

Spin and charge transport in materials with spin-dependent conductivity

V. Zayets*

*Spintronic Research Center, National Institute of Advanced Industrial Science and Technology (AIST),
Umezono 1-1-1, Tsukuba, Ibaraki, Japan*

(Received 28 June 2012; published 16 November 2012)

The spin and charge transport in materials with spin-dependent conductivity has been studied. It has been shown that there is a charge accumulation along spin diffusion in a ferromagnetic metal, which causes a shortening of the spin diffusion length. It has been shown that there is a substantial interaction between the drift and diffusion currents in semiconductors. The effects of gain/damping of a spin current by a charge current and the existence of a threshold spin current in a semiconductor have been described. Because of the substantial magnitude, these new spintronics effects might be used for new designs of efficient spintronic devices. The influence of a spin drain on spin transport has been studied.

DOI: [10.1103/PhysRevB.86.174415](https://doi.org/10.1103/PhysRevB.86.174415)

PACS number(s): 75.76.+j, 85.75.—d

I. INTRODUCTION

Spintronics is a new type of electronics that exploits the spin degree of freedom of an electron in addition to its charge. There are many expectations that in the near future spintronic devices will be competitive with modern Si-electronic devices. It is expected that spintronic devices will be faster, more compact, and more energy saving.

In the last decade there were significant advances in the field of spintronics. New effects, new functions, and new devices were explored. The spin polarized current was efficiently injected from a ferromagnetic metal into a nonmagnetic metal and a semiconductor,¹⁻⁷ the method of electrical detection of spin current was developed,^{7,8} the spin Hall effect⁹ and the inverse spin Hall effect¹⁰ were experimentally measured, and the operation of a spin transistor¹¹ and tunnel spin transistor¹²⁻¹⁴ were experimentally demonstrated.

However, the efficiency of spintronic devices is still low. For example, the operation of a spin transistor was experimentally demonstrated,¹¹ but the spin transistor operates only at low temperature and its output voltage is only a few microvolts. This voltage is too low for the transistor to be utilized in practical devices. This is the general tendency, except for devices based on a magnetic tunnel junction (MTJ).^{15,16} At present, most spintronic devices either operate at cryogenic temperatures or have a spin-dependent output signal, which is just a little above noise level.⁷⁻¹¹ It is important to improve the performance of spintronic devices, otherwise they have no chance of competing with modern Si-electronic devices. For example, comparing the metal-oxide-semiconductor field-effect transistor (MOSFET) and the spin transistor, in the case of a MOSFET the channel conductivity varies by several orders of magnitude between the on and off states, while in the spin transistor the voltage varies only by a few tenth of a percent. Here we study new spin-related effects, which might help to make spintronic devices more efficient and more competitive with Si electronics. We describe the effects of gain/damping of a spin current by a charge current and the existence of a threshold spin current in a semiconductor. An advantage of these new spin-related effects is that they may have significant magnitude. As shown below, due to these effects the conductivity of a semiconductor can be varied by a spin current within a broad range, which is comparable with the

range of conductivity variation in the channel of a MOSFET. Spintronic devices utilizing these effects may not only have new functions such as switching by spin current, but also be competitive in performance with Si devices.

In data processing circuits, a spin current cannot be used as an input or output of a spintronic device (for example, a spin transistor), a charge current or an electrical voltage must be used. That implies that a spintronic device may operate efficiently only in the case when it utilizes an efficient conversion between spin current and charge current. For the last 20 years, spin transport in solids was successfully described by the Valet-Fert spin diffusion equation.¹⁷ The Valet-Fert equation describes spin diffusion from regions of larger spin accumulation towards regions of smaller spin accumulation. It does not include any term describing the interaction between a spin current and a charge current. Within the Valet-Fert theory spin current may interact with charge current only at a boundary between two materials. Therefore, the efficient conversion between the charge and spin currents and the efficient operation of the spintronics device may only be achieved in the case when the device is utilizing interfaces with significantly spin-dependent resistance [for example, giant magnetic resistance (GMR) or tunnel magnetic resistance (TMR)]. This requirement limits the range of possible designs of spintronic devices and it is technologically challenging to fabricate interfaces with high spin selectivity.

Recently, it was noticed that the Valet-Fert equation is not sufficient for the description of all features of spin transport in ferromagnetic metals¹⁸ and semiconductors.¹⁹ In Sec. II we will show that in the case of a material with spin-dependent conductivity the requirement of spin and charge conservation leads to the spin/charge transport equations, which are more complex than the Valet-Fert equation. These equations include terms that describe the interaction between charge and spin currents. As a result, the spin/charge transport equations do not exclude the possibility of conversion between spin and charge currents in the bulk of the material. This opens more possibilities for the design and fabrication of more efficient spintronic devices. In Sec. III we will show that in the limit case when the conductivity of a material is spin independent, the obtained spin/charge transport equations converge to the Valet-Fert spin transport equation. In Sec. IV we study the spin/charge transport in a ferromagnetic metal. Even though

in the bulk of ferromagnetic metals there is no interaction between the dc spin and charge currents, we show that there is a charge accumulation along the spin diffusion. That leads to the interaction between ac spin and charge currents in the bulk of the ferromagnetic metal. In Secs. V, VI, and VII we study unique features of the spin transport in the semiconductors, which is greatly influenced by the interaction between charge and spin currents. In Sec. VIII the influences of spin drain on the spin transport are explained.

II. SPIN AND CHARGE TRANSPORT EQUATIONS IN MATERIALS WITH SPIN-DEPENDENT CONDUCTIVITY

In this section the spin and charge transport equations for materials with spin-dependent conductivity are derived from the spin and charge conservations laws. The spin/charge transport equations describe the diffusion of electrons from regions of higher spin/charge concentration to regions of lower spin/charge concentration. Also, they describe a drift of electrons under an applied electrical field.

A material may have a different conductivity $\sigma_{\uparrow}, \sigma_{\downarrow}$ for spin-up and spin-down electrons, which can be described as

$$\begin{pmatrix} \sigma_{\uparrow} \\ \sigma_{\downarrow} \end{pmatrix} = 0.5\sigma \left[1 + \beta \begin{pmatrix} 1 \\ -1 \end{pmatrix} \right], \quad (1)$$

where we define σ as the effective conductivity and β as the spin selectivity

$$\sigma = \sigma_{\uparrow} + \sigma_{\downarrow}, \quad \beta = \frac{\sigma_{\uparrow} - \sigma_{\downarrow}}{\sigma_{\uparrow} + \sigma_{\downarrow}}. \quad (2)$$

We assume that within each spin band the electrons are in a thermal equilibrium. As result, the diffusion and drift of electrons in spin-up and spin-down bands can be described by spin-dependent chemical potentials μ_{\uparrow} and μ_{\downarrow} . Instead of μ_{\uparrow} and μ_{\downarrow} , it is more convenient to use charge chemical potential μ_{charge} and the spin chemical potential μ_{spin} defined as

$$\begin{pmatrix} \mu_{\uparrow} \\ \mu_{\downarrow} \end{pmatrix} = \mu_{\text{charge}} \begin{pmatrix} 1 \\ 1 \end{pmatrix} + \mu_{\text{spin}} \begin{pmatrix} 1 \\ -1 \end{pmatrix} \quad (3)$$

The charge chemical potential μ_{charge} describes the drift and accumulation of charge and the spin chemical potential μ_{spin} describes diffusion and accumulation of the spin. A drift and diffusion of electrons in each spin band are described by Ohm's law

$$\vec{J}_{\uparrow, \downarrow} = \sigma_{\uparrow, \downarrow} \nabla \mu_{\uparrow, \downarrow}, \quad (4)$$

where $J_{\uparrow, \downarrow}$ and $\sigma_{\uparrow, \downarrow}$ are currents and conductivities for spin-up and spin-down electrons, respectively.

The flow of charge and flow of spin are described by charge and spin currents, respectively. They can be calculated as

$$\vec{J}_{\text{charge}} = \vec{J}_{\uparrow} + \vec{J}_{\downarrow}, \quad \vec{J}_{\text{spin}} = \vec{J}_{\uparrow} - \vec{J}_{\downarrow}. \quad (5)$$

Substituting (3) and (4) into (5), the charge and spin currents are calculated as

$$\begin{aligned} \vec{J}_{\text{charge}} &= \sigma (\nabla \mu_{\text{charge}} + \beta \cdot \nabla \mu_{\text{spin}}), \\ \vec{J}_{\text{spin}} &= \sigma (\nabla \mu_{\text{spin}} + \beta \cdot \nabla \mu_{\text{charge}}). \end{aligned} \quad (6)$$

The continuity equations for charge and spin read

$$\nabla \cdot \vec{J}_{\text{charge}} = \frac{\partial \rho_{\text{charge}}}{\partial t}, \quad \nabla \cdot \vec{J}_{\text{spin}} = \frac{\partial \rho_{\text{spin}}}{\partial t}, \quad (7)$$

where $\rho_{\text{charge}}, \rho_{\text{spin}}$ are the charge and spin density, respectively.

In the static case there is no charge dissipation

$$\frac{\partial \rho_{\text{charge}}}{\partial t} = 0. \quad (8)$$

In the Appendix it is shown that

$$\frac{\partial \rho_{\text{spin}}}{\partial t} = \sigma \frac{\mu_{\text{spin}}}{l_s^2}, \quad (9)$$

where l_s is defined as the intrinsic spin diffusion length.

Substituting (6), (8), and (9) into (7), the charge/spin transport equations are obtained as

$$\begin{aligned} \nabla \cdot [\sigma (\nabla \mu_{\text{charge}} + \beta \cdot \nabla \mu_{\text{spin}})] &= 0, \\ \nabla \cdot [\sigma (\nabla \mu_{\text{spin}} + \beta \cdot \nabla \mu_{\text{charge}})] &= \sigma \frac{\mu_{\text{spin}}}{l_s^2}. \end{aligned} \quad (10)$$

It should be noticed that Eqs. (10) are derived only utilizing the spin/charge conservation laws and Ohm's law. Therefore, their validity extends over a wide range of materials and structures.

In following sections we distinguish three types of materials in which the spin transport are substantially different. The first type of material is nonmagnetic metals, in which the conductivity is spin independent. The second type of material is ferromagnetic metals, in which the conductivity is spin dependent and it is a constant throughout the whole material. The conductivity of ferromagnetic metals does depend on spin or/and charge accumulation within it. The third type of material is semiconductors. The conductivity of semiconductors does depend on spin or/and charge accumulation within it. The conductivity of semiconductors becomes spin dependent in the presence of a spin accumulation within it.

III. NONMAGNETIC METALS

A nonmagnetic metal is defined here as a conductive material, the conductivity of which is independent on spin polarization ($\beta = 0$).

In the case when $\beta = 0$, Eqs. (10) can be simplified to

$$\nabla \cdot [\sigma \nabla \mu_{\text{charge}}] = 0, \quad (11)$$

$$\nabla \cdot [\sigma \nabla \mu_{\text{spin}}] = \sigma \frac{\mu_{\text{spin}}}{l_s^2}. \quad (12)$$

Equation (11) describes the charge transport. Equation (12) is the Valet-Fert equation,¹⁷ which describes spin diffusion.

A solution of Eq. (11) describes a drift charge current \vec{J}_{charge} , which is drifted along an applied electrical field \vec{E} ,

$$\vec{J}_{\text{charge}} = \sigma \vec{E}, \quad \nabla \mu_{\text{charge}} = \vec{E}. \quad (13)$$

The Valet-Fert spin-diffusion equation (12) has a general solution

$$\mu_{\text{spin}}(\vec{r}) = \oint \mu_{\text{spin}}(\vec{s}) e^{-\frac{r-\vec{s}}{l_s}} d\vec{s}, \quad (14)$$

where \vec{s} is a unit vector directed towards the flow direction of the spin current. Along the diffusion direction, the spin accumulation and the spin current exponentially decay.

As follows from Eqs. (11) and (12), in nonmagnetic metals there is no interaction between the drift charge current and the diffusion spin current.

IV. FERROMAGNETIC METALS

In a ferromagnetic metal at Fermi energy there is a difference in the number of states for electrons, where spins are directed along and opposite to the metal magnetization direction. Since the conductivity of the metal is proportional to the number of carries participating in the transport and the number of spin-up and spin-down electrons is different, the conductivity of a ferromagnetic metal is different for spin-down and spin-up electrons. This difference in the conductivities is a constant throughout the bulk of the material and it is independent of the charge and the spin accumulation in the metal. As result, the spin selectivity β in the ferromagnetic metal is nonzero and it is a constant throughout the metal. A drift spin current and a charge accumulation along the spin diffusion current are features of spin transport in the ferromagnetic metals.

In the case when β is a constant, the spin/charge transport equations (10) can be simplified to

$$\nabla \cdot [\sigma \nabla \mu_{\text{charge}}] = -\frac{\beta}{1-\beta^2} \sigma \frac{\mu_{\text{spin}}}{l_S^2}, \quad (15)$$

$$\nabla \cdot [\sigma \nabla \mu_{\text{spin}}] = \frac{1}{1-\beta^2} \sigma \frac{\mu_{\text{spin}}}{l_S^2} = \sigma \frac{\mu_{\text{spin}}}{l_{S,\text{eff}}^2}, \quad (16)$$

where

$$l_{S,\text{eff}} = l_S \sqrt{1-\beta^2}. \quad (17)$$

The transport equations (15) and (16) are simpler than the general spin/charge transport equations (10), because the solution of Eqs. (15) and (16) can be separated into two solutions. The first solution describes the drift current and the second solution describes the diffusion current. The same as in the case of nonmagnetic metals, in ferromagnetic metals there is no interaction between the dc diffusion and drift currents. However, as it is shown below in ferromagnetic metals, there is an interaction between the ac diffusion and drift currents, because of a charge accumulation along spin diffusion.

The first solution of Eqs. (13) and (14) corresponding to the drift current is

$$\mu_{\text{spin}} = 0. \quad (18)$$

Equation (18) means that there is no spin accumulation along the drift current.

Substituting (18) into (6), the spin and charge components of the drift current are calculated as

$$\begin{aligned} \vec{J}_{\text{charge}} &= \sigma \nabla \mu_{\text{charge}} = \sigma \vec{E}, \\ \vec{J}_{\text{spin}} &= \beta \sigma \nabla \mu_{\text{charge}} = \beta \sigma \vec{E}. \end{aligned} \quad (19)$$

The drift current has both a spin-current component and a charge-current component. In contrast to the diffusion spin current, the drift spin current does not decay with the propagation distance and there is no spin relaxation along the flow of the spin drift current.

The second solution of Eqs. (15) and (16) corresponding to a diffusion spin current is

$$\mu_{\text{spin}} \neq 0. \quad (20)$$

There is a spin accumulation along the flow of the diffusion spin current. The set of Eqs. (15) and (16) has two unknowns: μ_{spin} and μ_{charge} . μ_{spin} can be found from Eq. (16). Equation (16) is the same as the Valet-Fert equation (12). As result, the solution for μ_{spin} is described by (14). However, the effective spin diffusion length (17) should be substituted in place of the intrinsic spin diffusion length (9). Knowing μ_{spin} , the μ_{charge} is found from (15) as

$$\mu_{\text{charge}} = -\beta \mu_{\text{spin}}. \quad (21)$$

Since the charge chemical potential is defined up to an additive constant, in Eq. (21) the condition $\mu_{\text{charge}} = 0$ was used when $\mu_{\text{spin}} = 0$.

The properties of the spin diffusion current are similar in ferromagnetic and nonmagnetic metals. However, the effective spin diffusion length in ferromagnetic metals is shorter, because in a ferromagnetic metal there is a charge accumulation along the flow direction of the spin current and the electrical field induced by this charge accumulation is slowing the spin diffusion.

The charge accumulation along the diffusion spin current is calculated from Gauss's law utilizing (21) as

$$\rho_{\text{charge}} = \nabla \cdot [\varepsilon \vec{E}] = \nabla \cdot [\varepsilon \nabla \mu_{\text{charge}}] = \nabla \cdot [\varepsilon \nabla (\beta \mu_{\text{spin}})], \quad (22)$$

where ρ_{charge} is the accumulated charge density and ε is the permittivity of the metal.

For example, in the case when spin diffusion is along the x direction, the spin chemical potential and charge accumulation are

$$\mu_{\text{spin}} = \mu_{\text{spin}0} e^{-\frac{x}{l_{S,\text{eff}}}}, \quad (23)$$

$$\rho_{\text{charge}} = -\beta \varepsilon \frac{\mu_{\text{spin}0}}{l_{S,\text{eff}}^2} e^{-\frac{x}{l_{S,\text{eff}}}}. \quad (24)$$

Figure 1 explains the physical mechanism for charge accumulation along the spin diffusion current in a ferromagnetic metal. The magnetization direction of the ferromagnetic metal is up. As result, the density of states for spin-up electrons is larger than the density of states for spin-down electrons. We assumed that there is a spin accumulation of spin-up electrons on the left side and there is a spin diffusion towards the right side. Since spin-up electrons are accumulated and the accumulation decays towards the right side, the chemical potential for spin-up electrons μ_{\uparrow} is higher than for spin-down electrons μ_{\downarrow} and the differences between the chemical potentials μ_{\uparrow} and μ_{\downarrow} decreases towards the right side. μ_{\uparrow} is decreasing and μ_{\downarrow} is increasing. That means that the spin-up electrons diffuse from the left side to the right side and spin-down electrons diffuse in the opposite direction. In the case when there is no charge accumulation [Fig. 1(a)], the slopes of μ_{\uparrow} and μ_{\downarrow} are of the same magnitude and of opposite signs. Since the density of states for spin-up electrons is greater than for spin-down electrons, more electrons diffuse towards the right side than towards the left side. Because of the unbalance of electrons diffusing in opposite directions,

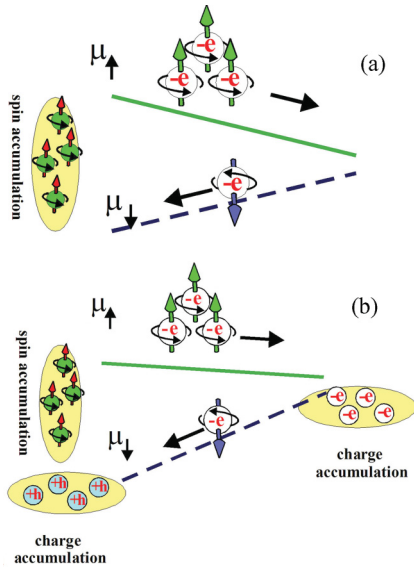


FIG. 1. (Color online) Physical mechanism for charge accumulation along the spin diffusion current in ferromagnetic metal. The solid (green) and dashed (blue) lines represent chemical potential for spin-up and spin-down electrons, respectively. (a) Spin-up electrons are accumulated on the left side and there is a spin diffusion of spin-up electrons towards the right side and spin-down electrons towards the left side. The absolute values of the slopes of the chemical potential for spin-up and spin-down electrons are the same. Since more spin-up electrons are participating in transport, diffusion of spin-up and spin-down electrons is unbalance, charge is accumulating and transport is not in equilibrium. (b) The charge is accumulated and the absolute value of the slope of the chemical potential for spin-up electrons is smaller than for spin-down electrons. The diffusion of spin-up and spin-down electrons is in balance and transport is equilibrium.

there is a charge current and the charge is accumulating in the bulk of the metal. The charge accumulation induces an electrical field. The direction of the electrical field is such that it reduces the slope of the chemical potential for spin up electrons and increases the slope for spin-down electrons [Fig. 1(b)]. As a result, the diffusion of spin-down electrons increases and the diffusion of spin-up electrons decreases. The charge accumulation proceeds until the diffusion of spin-down electrons from right to left will be equal to the diffusion of spin-up electrons from left to right.

As described by Eq. (24), charge accumulation is larger in a material with shorter spin diffusion length. The materials with the largest spin selectivity $\beta \sim 1$ have the shortest effective spin diffusion length [see Eq. (17)] and the largest charge accumulation. A half-metal is an imaginary material in which the density of states for one spin band is zero near the Fermi energy and electrons of only one spin polarization are able to participate in the transport. In the case of half-metals, the spin selectivity $\beta = 1$ and the spin diffusion length becomes zero [see Eq. (17)], meaning that in half-metals a spin diffusion cannot occur. This fact can be understood as follows. For example, if in some region inside a half-metal a spin accumulation is created, the spin accumulation will try to spread out from this region into a surrounding. In the half-metals only electrons of one spin direction are participating

in transport. Therefore, if there is a spin diffusion, it is accompanied by a corresponded charge diffusion. Due to the diffused charge, a voltage is built between the surrounding and the spin accumulation region. This voltage drifts the electrons in the opposite direction to diffusion and the spin diffusion stops. Another feature of half-metals is an infinite spin life, because in half-metals there are electrons of only one spin direction and there is no any spin relaxation path. Therefore, if a spin accumulation is created in a half-metal, it will stay in there without spreading or relaxation.

As shown below, the absence of spin diffusion at $\beta = 1$ is the reason for a threshold spin current in a semiconductor. The diffusion spin current in a semiconductor cannot exceed the threshold spin current.

As an example, in the ferromagnetic metal ($\beta = 0.5$, $\varepsilon = 10$) the spin accumulation of $\mu_{\text{spin}} = 1$ mV is accompanied by an accumulated electron density of 2.8×10^{11} and $2.8 \times 10^{15} \text{ cm}^{-3}$ in the cases of the effective spin diffusion length of $1 \mu\text{m}$ and 10 nm , respectively. In this example, the accumulated electron density is several orders of magnitude smaller than the density of conductive electrons in the metal.

As was shown above, in a ferromagnetic metal the drift and spin currents flow independently and there is no conversion between them. It is important to clarify the conditions when the drift spin current may be converted into the spin diffusion current. Equations (15) and (16) do not describe any conversion between drift and diffusion spin currents. These equations were derived from the general spin/charge transport equations (10) only under one condition: $\nabla\beta = 0$. Therefore, it can be concluded that the conversion of drift spin current into diffusion spin is only possible when

$$\nabla\beta \neq 0. \quad (25)$$

Condition (25) may be satisfied at the boundary between two materials. For example, the conversion of a drift spin current in a ferromagnetic metal into a diffusive spin in a nonmagnetic metal is called spin injection. The effective spin injection is important for the operation of spintronic devices.

In the following section we will show that condition (25) is satisfied in the volume of semiconductors. Therefore, in the volume of a semiconductor, the spin drift current is continuously converted into the diffusion spin current.

V. SEMICONDUCTORS

In a semiconductor the spin selectivity β is not constant throughout the bulk of the material. At each point it is a function of the magnitude of the spin accumulation there. Because of this condition, there are several unique features of spin transport in the semiconductors such as a spin conversion between a drift and diffusion currents; an existence of a threshold spin current; and a gain/damping of the spin current by a charge current.

In the following we will derive a set of equations which describe the spin and charge transport in nondegenerate semiconductors. In the case of a nondegenerate n -type semiconductor, the number of electron in conduction band is

$$n = N_c e^{\frac{E_F - E_c}{kT}}, \quad (26)$$

where N_c is the effective density of states in the conduction band, E_F is the Fermi energy, and E_c is the energy of the bottom of the conduction band.

In a semiconductor both the charge and spin can be accumulated. In the case when there is a charge accumulation, the number of electron in the conduction band is calculated as

$$N_c e^{\frac{E_F - E_c}{kT}} = N_{\text{Doping}} + n_{\text{accumul}}, \quad (27)$$

where N_{Doping} , n_{accumul} are the doping concentration and the concentration of accumulated electrons, respectively.

In the case when additionally there is a spin accumulation, the number of spin-up and spin-down electrons in the conduction band is calculated as

$$\begin{pmatrix} n_{\uparrow} \\ n_{\downarrow} \end{pmatrix} = N_c e^{\frac{E_F - E_c}{kT}} \begin{pmatrix} e^{\frac{\mu_{\text{spin}}}{kT}} \\ e^{-\frac{\mu_{\text{spin}}}{kT}} \end{pmatrix}. \quad (28)$$

Noticing that in a nondegenerated semiconductor the mobility only weakly depends on charge and spin accumulations, the conductivity for spin-up and spin-down electrons can be calculated as

$$\begin{pmatrix} \sigma_{\uparrow} \\ \sigma_{\downarrow} \end{pmatrix} = e \cdot M (N_{\text{Doping}} + n_{\text{accumul}}) \cdot \begin{pmatrix} e^{\frac{\mu_{\text{spin}}}{kT}} \\ e^{-\frac{\mu_{\text{spin}}}{kT}} \end{pmatrix}, \quad (29)$$

where M is the mobility. The effective conductivity σ and spin selectivity β in a semiconductor are calculated from (29) as

$$\sigma = \sigma_{\uparrow} + \sigma_{\downarrow} = 2e \cdot M (N_{\text{Doping}} + n_{\text{accumul}}) \cdot \cosh\left(\frac{\mu_{\text{spin}}}{kT}\right), \quad (30)$$

$$\beta = \frac{\sigma_{\uparrow} - \sigma_{\downarrow}}{\sigma_{\uparrow} + \sigma_{\downarrow}} = \tanh\left(\frac{\mu_{\text{spin}}}{kT}\right). \quad (31)$$

Equations (30), (31) and (10) and Gauss's law form a full set of equations describing the charge and spin transport of electrons in semiconductors. (For the holes, a similar set of equation can be derived.) Therefore, in n -type semiconductors the spin and charge transport are described by the following set of five equations in five unknowns (μ_{charge} , μ_{spin} , σ , β , n_{accumul}):

$$\nabla \cdot [\sigma (\nabla \mu_{\text{charge}} + \beta \cdot \nabla \mu_{\text{spin}})] = 0, \quad (32a)$$

$$\nabla \cdot [\sigma (\nabla \mu_{\text{spin}} + \beta \cdot \nabla \mu_{\text{charge}})] = \sigma \frac{\mu_{\text{spin}}}{l_s^2}, \quad (32b)$$

$$\rho_{\text{charge}} = e \cdot n_{\text{accumul}} = \nabla \cdot [\varepsilon \vec{E}] = \nabla \cdot [\varepsilon \nabla \mu_{\text{charge}}], \quad (32c)$$

$$\sigma = 2e \cdot M \cdot (N_{\text{doping}} + n_{\text{accumul}}) \cosh\left(\frac{\mu_{\text{spin}}}{kT}\right), \quad (32d)$$

$$\beta = \tanh\left(\frac{\mu_{\text{spin}}}{kT}\right). \quad (32e)$$

The equations of the set (32) are non-linear and in a general case they should be solved numerically.

VI. THRESHOLD DIFFUSION SPIN CURRENT

A unique feature of spin transport in a semiconductor is the existence of a threshold spin current, above which the

diffusion spin current is unable to flow and spin diffusion is stopped. In the case when an input spin current is slightly below the threshold current, the region of significant spin and charge accumulations is formed close to the input of the spin current. Only a small amount of spin current diffuses out of this region. The spin and charge accumulation in this region are substantial and the region's transport properties may be controlled within a wide range by varying the input spin current. That makes this effect attractive for new designs of effective spintronic devices.

To demonstrate this effect we have solved numerically the set of equations (32) by the finite difference method (FDM) for an n -Si bar (mobility of $1450 \text{ cm}^2/\text{Vs}^{-1}$, spin diffusion length of $1 \text{ }\mu\text{m}$, and doping concentration of 10^{16} cm^{-3}). The Neumann boundary conditions of zero charge current and a given value of spin current were used as the boundary conditions on the left side of the bar. Open-boundary conditions for the spin current and a zero value for the charge chemical potential were used as the boundary conditions on the right side of the bar. Figure 2 shows the calculated spin chemical potential μ_{spin} ,

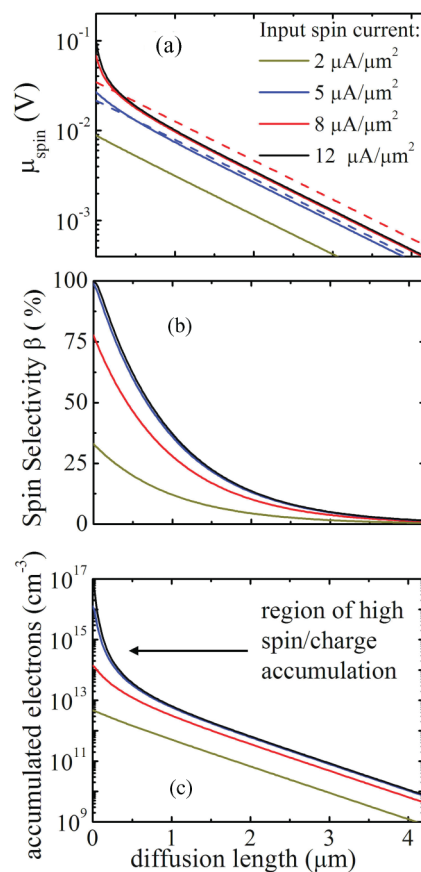


FIG. 2. (Color online) Threshold spin current in the semiconductor. (a) Spin chemical potential, (b) spin selectivity, and (c) density of accumulated electrons for diffusive spin current propagating along n -Si bar (doping concentration 10^{16} cm^{-3}). The region of high spin/charge accumulation is from 0 to $\sim 0.2 \text{ }\mu\text{m}$. The dash lines in (a) shows the case when spin current flow in a nonmagnetic metal having the same spin diffusion length and the same conductivity. In cases (a) and (c) the scale of the y axis is logarithmic. Spin chemical potential, spin selectivity, and density of accumulated electrons increase when input spin current increases.

the spin selectivity β , and the accumulated electrons density. In the case when the input current is below $2 \mu\text{A}/\mu\text{m}^2$ the spin selectivity β and the charge accumulation are small and the spin diffusion in the semiconductor is almost the same as the spin diffusion in a nonmagnetic metal. The decay of the spin current J_{spin} and the spin chemical potential μ_{spin} follow the exponential law with the effective spin diffusion length equal to the intrinsic spin diffusion length in the semiconductor. This corresponds to the straight dark-yellow line of Fig. 2(a). However, for larger magnitudes of the input spin current, the spin diffusion in semiconductors becomes different from the spin diffusion in nonmagnetic metals and the region of high spin/charge accumulation is formed. The decay of spin chemical potential μ_{spin} deviates from the exponential law [red, blue, and black lines of Fig. 2(a)]. Inside the accumulation region, the spin charge accumulation is larger compared to the case of a nonmagnetic metal. Outside this region the spin accumulation is smaller. As can be seen from Fig. 2(c), the large spin accumulation is accompanied by a large charge accumulation.

The physical mechanism for the formation of a region of high spin/charge accumulation is explained as follows. As can be seen from Fig. 2(b), in case of a small input spin current, the spin selectivity β in a semiconductor is small and it has a little influence on the transport. In the case when the input spin current exceeds $5 \mu\text{A}/\mu\text{m}^2$, the spin selectivity β approaches 100% in the region close to the input. As has been shown in Sec. IV, in the case when the spin selectivity β approaches 100%, the spin transport drastically changes. The effective spin length shortens, significant charge is accumulated, and eventually spin diffusion stops. In a semiconductor, the spin selectivity β increases with the increase of the magnitude of the spin current. Inside the region near the input where β approaches 100%, the spin diffusion length significantly shortens, meaning that there spin diffusion practically stops. Only a small amount of spin current leaks from this region. Since spin current does not diffuse out of this region, more spin is accumulated there, causing an even larger β and an even larger spin accumulation. Therefore, the process of spin/charge accumulation is avalanchelike. As can be seen from Fig. 2(a), when the input spin current increases further from 8 to $12 \mu\text{A}/\mu\text{m}^2$, the amount of the spin current leaked from the accumulation region almost does not change. This means the spin current cannot pass into the Si bar and so the majority of the spin current decays inside the spin/charge accumulation region.

Even though the explained effect limits the amount of spin current, which could pass through the semiconductor, the effect may be used in some applications. For example, the electron accumulation in the spin/charge accumulation region may significantly exceed the doping concentration in the semiconductor. This leads to a substantial increase of the conductivity of this region, meaning that a spin current may switch a semiconductor from a weakly conductive state into a larger conductivity state.

It should be noticed that the threshold spin current decreases with the decrease of the doping concentration and with the increase of the spin diffusion length.

VII. GAIN/DAMPING OF DIFFUSION SPIN CURRENT BY DRIFT CHARGE CURRENT

In the previous section the properties of the diffusion spin current in a semiconductor have been studied in the absence of any drift current. When drift and diffusion currents flows along the same direction, there is an interaction between them. One consequence of this interaction is a gain/damping of the spin current by the charge current.

As an example, the spin and charge transport in the *n*-Si bar (mobility of $1450 \text{ cm}^2/\text{Vs}^{-1}$, spin diffusion length of $1 \mu\text{m}$, and doping concentration of 10^{16} cm^{-3}) was calculated by numerically solving Eqs. (32) by the FDM. The Neumann boundary conditions for the given values of the spin and charge currents were used as the boundary conditions. The input spin current was $2 \mu\text{A}/\mu\text{m}^2$.

Figure 3(a) shows the calculated spin chemical potential μ_{spin} for different values of the input charge current. For any input charge current, $\log(\mu_{\text{spin}})$ is a straight line. This means that despite the fact that the spin transport in semiconductors is described by a set of nonlinear equations and there is a significant interaction between the charge and spin currents, still the decay of the spin chemical potential μ_{spin} is practically exponential, meaning that the spin transport can be described by an effective spin diffusion length. As can be seen from Fig. 3(a), the effective spin diffusion length increases when the charge and spin currents flow in the same direction, and the effective spin diffusion length decreases when the charge and spin currents flow in the opposite directions. When the charge current flows along the spin current, the spin current gains from the charge current so that the spin relaxation becomes slower and the spin length becomes longer. For the opposite direction of the charge current, the spin current is damped by the charge current so that the spin relaxation becomes faster and the spin length becomes shorter. It was calculated that the

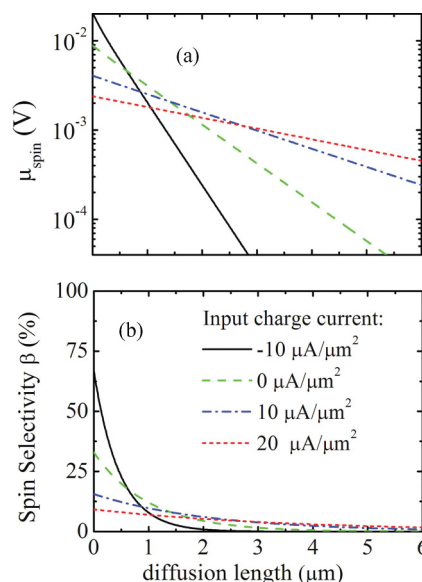


FIG. 3. (Color online) The gain/damping of diffusive spin current by drift charge current. Density of input spin current is $2 \mu\text{A}/\mu\text{m}^2$. (a) Spin chemical potential μ_{spin} . (b) Spin selectivity β .

effective spin length does not depend on the magnitude of the input spin current.

The physical mechanism for the gain/damping of the spin current by the charge current is described as follows. The spin selectivity β in semiconductors is a function (31) of the spin accumulation. As was explained in Sec. III, in materials with nonzero spin selectivity β the drift current is spin polarized and the magnitude of the spin-current component of the drift current is linearly proportional to β [see Eq. (19)]. This means that in the semiconductor the drift current is spin polarized, only when it flows together with the diffusion spin current. Along the diffusion direction of spin current, the spin accumulation exponentially decays and consequently the spin selectivity β decays as well. Figure 3(b) shows the spin selectivity β for different values of the input charge current. Since β decreases, the spin component of the drift current decreases as well. Because of the spin conservation law, the spins are converted from drift current to diffusion current. When the polarity of the converted spins is the same as the spin polarity of diffusion current, the diffusion current gains the spins and the decay of diffusion current becomes slower. When the polarity of the conversion is different, the diffusion current is damped and the decay of diffusion current becomes faster.

Figure 4(a) shows the diffusion spin current, the spin-current component of the drift current, and their sum for the case when the drift current flows along the direction of the diffusion current. The polarity of the drift and diffusion spin currents are the same and the magnitude of each current is smaller than the magnitude of total spin current. Figure 4(b) shows the diffusion spin current, the spin-current component of drift currents, and their sum for the case when the drift and diffusion currents flow in opposite directions. The polarities of the drift and diffusion spin currents are oppo-

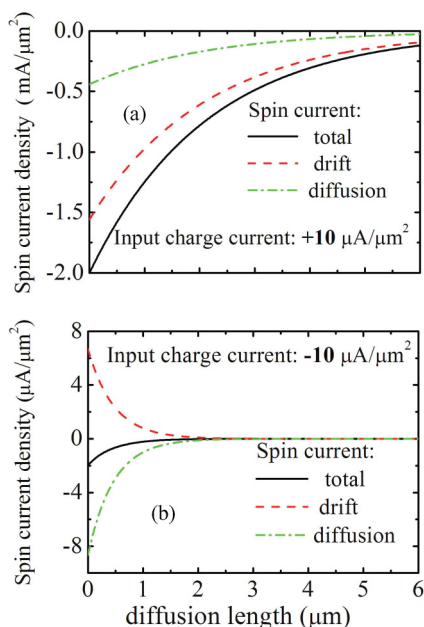


FIG. 4. (Color online) The total, drift, and diffusion spin currents in case when the drift current flows (a) along diffusion current and (b) opposite to diffusion current. Input spin current: $2 \mu\text{A}/\mu\text{m}^2$. Input charge current: (a) $10 \mu\text{A}/\mu\text{m}^2$ and (b) $-10 \mu\text{A}/\mu\text{m}^2$.

site and the magnitudes of both diffusion and spin currents are substantially larger than the magnitude of the total spin current.

It should be noticed that spin relaxation affects only the diffusion current. There is no spin relaxation for the drift spin current. The drift spin current is losing its spin-current component only due the conversion of spins into the diffusion current. The spin relaxation is weakest for a given total spin current when the drift spin current is largest and diffusion spin current is smallest. For the same total input spin current, the magnitude of the diffusion spin current is significantly smaller and as a consequence the spin relaxation is weaker in the case when the flow directions of the charge and spin currents are the same, than in the case when the directions are opposite (Fig. 4). Therefore, since spin relaxation is proportional to the magnitude of the diffusion spin current, the spin relaxation in semiconductors may be modulated by a charge current.

Even though spin/charge transport in the semiconductors is described by a set of nonlinear equations, it is possible to find the analytical expression for the effective spin diffusion length. It is necessary to use several approximations. However, in many cases the analytical expression for the effective diffusion length is a good approximation, which describes well the spin transport in semiconductors. Substituting (6) into (32b) gives

$$(1 - \beta^2) \nabla \cdot (\sigma \nabla \mu_{\text{spin}}) + \nabla \beta \cdot J_{\text{charge}} - 2 \cdot \nabla \beta \cdot \beta \cdot \sigma \nabla \mu_{\text{spin}} = \sigma \frac{\mu_{\text{spin}}}{l_S^2}. \quad (33)$$

In order to solve Eq. (33) the following approximations are used. The spin current is assumed to be sufficiently below the threshold current. It is assumed that there are no regions of large spin or charge accumulation. The convection term $\nabla \beta \cdot \beta \cdot \sigma \nabla \mu_{\text{spin}}$ is ignored. The conductivity and charge current are assumed to be a constant throughout the material. Therefore, Eq. (33) is simplified to

$$\nabla \cdot (\nabla \mu_{\text{spin}}) + \nabla \beta \frac{J_{\text{charge}}}{\sigma} = \frac{\mu_{\text{spin}}}{l_S^2}. \quad (34)$$

Differentiating Eq. (32e) gives

$$\nabla \cdot \beta = \left[\text{sech} \left(\frac{\mu_s}{kT} \right) \right]^2 \frac{1}{kT} \nabla \cdot \mu_s. \quad (35)$$

In the case of a small spin accumulation when $\mu_s/kT \ll 1$, Eq. (35) is simplified to

$$\nabla \cdot \beta = \frac{1}{kT} \nabla \cdot \mu_s. \quad (36)$$

Substituting (36) into (34) gives

$$\nabla \cdot (\nabla \mu_{\text{spin}}) + \frac{1}{kT\sigma} \nabla \cdot \mu_{\text{spin}} \cdot J_{\text{charge}} = \frac{\mu_{\text{spin}}}{l_S^2}. \quad (37)$$

The solution of Eq. (37) is the same as the solution (14) of the Valet-Fert equation (12), but instead of the intrinsic spin diffusion length l_S the effective spin diffusion length $l_{s,\text{eff}}$ should be used

$$l_{s,\text{eff}} = \frac{l_S}{\sqrt{1 + \left(\frac{J_{\text{charge}} l_S}{2kT\sigma} \right)^2 + \frac{J_{\text{charge}} l_S}{2kT\sigma}}}. \quad (38)$$

Figure 5 shows the effective spin diffusion length $l_{s,\text{eff}}$ in n -Si ($N_d = 10^{16} \text{ cm}^{-3}$). The black line is obtained by

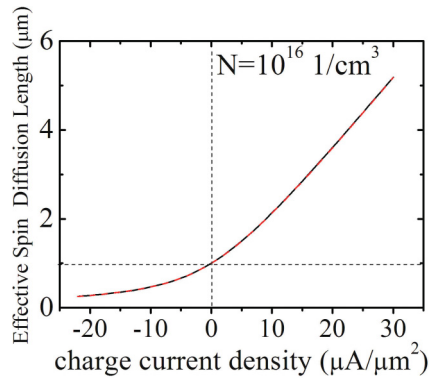


FIG. 5. (Color online) Effective spin diffusion length in n -Si ($N_d = 10^{16} \text{ cm}^{-3}$). The solid (black) line is obtained by fitting FDM solutions of Fig. 3. The dashed (red) line is calculated from Eq. (38).

fitting the FDM solutions of Fig. 3. The red line is calculated from Eq. (38). The difference between the lines is less than 1%. Therefore, despite the somewhat rough approximations used, Eq. (38) well describes the interaction between the spin and charge currents in semiconductors in cases when the spin current is sufficiently below the threshold spin current.

It should be noticed that the charge current can modulate the threshold spin current. As was described in the previous section, the threshold spin current is the maximum diffusion spin current, which can flow in a semiconductor. In the case when the input spin current is fixed and the input charge current is varied, the magnitude of the diffusion spin current may change significantly (see Fig. 4). Therefore, the charge current may turn the diffusion spin current to or out of the threshold conditions when the spin diffusion is stopped and a region of high spin and charge accumulation is formed. As result, the charge current may switch the spin diffusion on and off.

VIII. SPIN DRAIN EFFECT

In contrast to the charge current, the flow of the spin current does not require a drain. However, the spin drain plays an important role for spin transport. In the following we will demonstrate that a spin drain substantially modifies spin diffusion and may change the effective spin diffusion length.

Even though a spin and a charge are undivided features of an electron, there is a significant difference between the flows of charge and spin in a solid. In contrast to the charge current, which always flows from source to drain, a flow of spin current does not require a drain. After having been emitted from a source, the spin current propagates in material until it decays.

Both a charge source and a charge drain are required in order for the charge current to flow. The charge is drifted by an electrical field from the charge source towards the charge drain. In the absence of the charge drain, the charge current does not flow. For example, in the imaginary case when there is no charge drain, but there a charge flow, the charge will be accumulated at some point. The accumulated charge will induce a long-range electrical field, which is in the opposite direction to the charge current. Therefore, the charge flow will stop.

In contrast, only a spin source is necessary for the spin current to flow. The flow of the spin current does not require

a spin drain. A spin accumulation does not induce any sufficiently strong long-range field, which may stop the spin diffusion. As a spin accumulation is created at the spin source, it diffuses from the regions of larger spin concentration towards the regions of smaller spin concentration.

Even though the spin current does not require a spin drain, the spin drain plays an important role in the spin transport. Any conductive material, in which the spin current rapidly decays, may be considered as a spin drain. A spin drain, which consists of a material of larger conductivity and of longer spin diffusion length, has the stronger influence on spin transport.

To demonstrate the influence of the spin drain on spin transport, we calculated the spin diffusion in three example structures. The first example will demonstrate that a spin drain attracts spins. The second example will demonstrate that the spin drain affects the spin diffusion length in a material. The third example demonstrates the influence of the sample shape on the spin drain effect. All structures consist of a metallic wire and a spin drain. The materials of the wire and the drain were nonmagnetic metals. The obtained results are valid also in the case of ferromagnetic metals and semiconductors, but the effective length (17) or (38) should be used instead of the intrinsic spin diffusion length (9). The solution was calculated by solving the Gerber-Fert diffusion equation (12) by the finite element method. The conductivity and thickness of the wires were $3.774 \times 10^7 \text{ S/m}$ and $1 \mu\text{m}$, respectively. The spin drain is a metallic wire with larger conductivity. The spin drain effectively attracts spin current only when its conductivity is significantly larger than the conductivity of other wires in the structure. In order to clarify the influence of the spin drain, the spin diffusion was compared between the case when the drain conductivity is smaller and the influence of spin drain is not significant, and the case when the drain conductivity is larger and the influence of spin drain is significant.

For the first example we have calculated the spin diffusion in a T-splitter, which consist of an input wire and two output wires (Fig. 6). There is a spin drain connected near the output of the second wire. The spin diffusion length in the wires of the splitter and in the drain is $5 \mu\text{m}$. Figure 6(a) shows the distribution of the spin current in the T-splitter in the case when the conductivity of the spin drain is the same as that of the wires of the T-splitter. In this case the spin drain has little influence on the spin transport and almost equal amounts of spin current split between the two ports. Figure 6(b) shows the case when the conductivity of the spin drain is 20 times larger than the conductivity of the wires of the T-splitter. The spin current is mostly directed into the spin drain, because the spin drain attracts the spin current.

Figure 7 shows the calculated output spin currents at ports 1 and 2 as a function of the ratio of the conductivity of the spin drain to the conductivity of the wire of the T-splitter. In the case when the conductivity of the spin drain is small, the influence of the spin drain on the spin transport is weak and the spin current is split almost equally between ports 1 and 2. As the conductivity of the spin drain decreases, more spin current decays inside the spin drain and the output spin current from ports 1 and 2 rapidly decreases. Since port 2 is closer to the spin drain, the reduction of the spin current at this port is more rapid. However, the influence of the spin drain on the spin current in port 1 is still

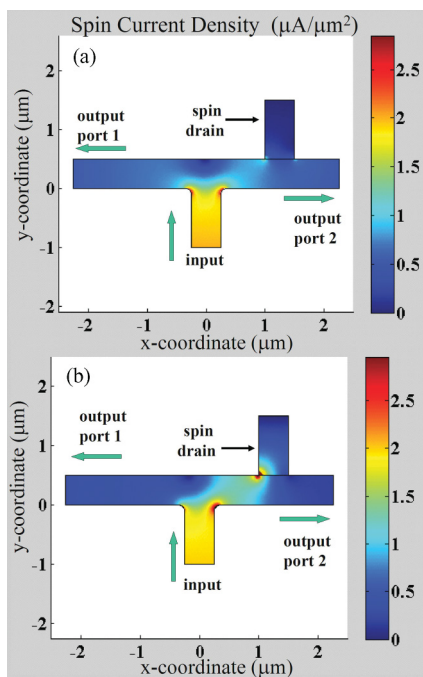


FIG. 6. (Color online) Distribution of spin current in T-splitter with spin drain. The T-splitter is made of a conductive metal wire. The spin drain is connected to the right arm of the T-splitter. The spin drain is a conductive wire made of another metal. (a) Conductivities of spin drain and T-splitter are the same. (b) Conductivity of spin drain is 20 times larger than conductivity of T-splitter.

significant despite the long distance between port 1 and the spin drain.

The second example demonstrates the influence of the spin drain on the effective spin diffusion length in a metallic wire. The structure consists of a straight metallic wire with the spin drain connected in the middle. Figure 8 shows the distribution of the spin current in this structure. In the case when the conductivity of the spin drain is smaller than the conductivity of the wire [Fig. 8(a)], the spin current mainly flows in the wire and only a little of the current enters the spin drain. In the case when the conductivity of the spin drain is larger than the conductivity of the wire [Fig. 8(b)], all spin current flows into the spin drain and only a little of current leaks into the wire. Figure 9 shows the magnitude of the spin current at the center of the wire along spin diffusion. The influence

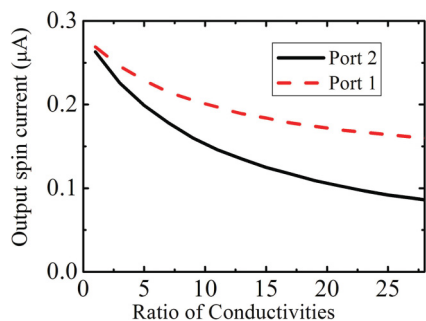


FIG. 7. (Color online) Output spin current at ports 1 and 2 of T-splitter of Fig. 6 as function of ratio of conductivity of spin drain to conductivity of T-splitter.

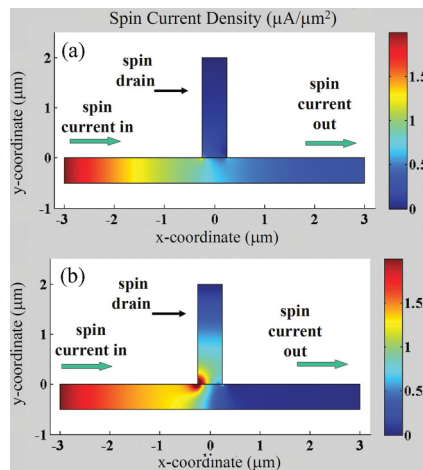


FIG. 8. (Color online) Spin current distribution in straight metallic wire connected to spin drain. The spin current flows from the left side to the right side of the wire. At the center of the wire the spin drain is connected. The spin drain is a conductive wire made of another metal. The spin diffusion length of the wire and the spin drain is $3 \mu\text{m}$. Ratio of conductivity of spin drain to conductivity of wire is (a) 0.4 and (b) 40.

of the spin drain on the spin diffusion length may be noticed from this figure. When the spin current has passed the spin drain, the spin drain does not affect the spin diffusion and the decay slope of the spin current in this region (x coordinate $> 0.5 \mu\text{m}$) is the same as in the case without the spin drain. However, in the region before the spin drain (x coordinate $< -0.5 \mu\text{m}$) the decay of the spin current is slower than in the case without the spin drain. That means the effective spin diffusion length becomes longer due to the spin drain. The reason for that is the attraction of spins by the spin drain. Since the spin current is attracted by spin drain, spin diffusion is faster and as result the spin current dissipates over a longer distance. Therefore, the effective spin diffusion length is shorter in the vicinity of a spin drain.

The spin drain is just a metallic wire having a sufficiently high conductivity and a sufficiently short spin diffusion length, meaning that any conductive wire may be considered as a spin drain. This implies that the shape of the wire might affect spin diffusion. The third example demonstrates the influence of the sample shape on the spin drain effect. The structure consists of two connected straight wires of different widths.

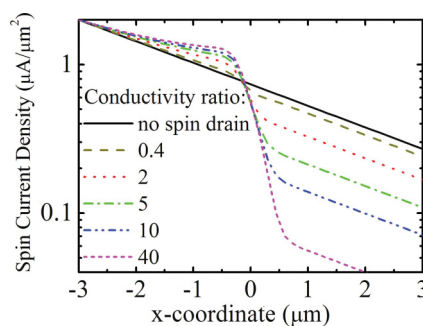


FIG. 9. (Color online) Magnitude of spin current along diffusion in the metallic wire connected to spin drain for different ratios of conductivity of spin drain to the conductivity of the wire.

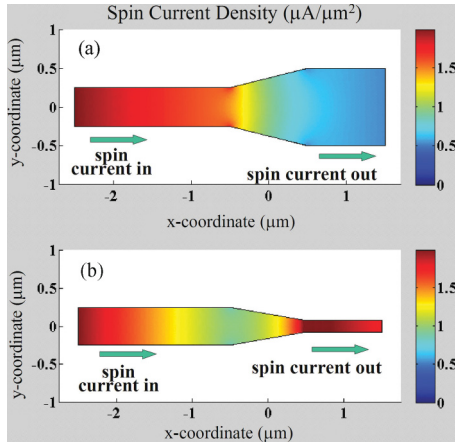


FIG. 10. (Color online) Spin current density in wire with variable width. The spin diffusion length in the wire is $5 \mu\text{m}$. Input of spin current is from the left side. Ratio of width of input wire to width of output wire is (a) 2 and (b) 0.3.

Figure 10 shows the distribution of spin current density for the two cases when the width of the output wire is narrower and when it is wider than that of the input wire. Figure 11 shows the magnitude of the spin current for different ratios of the width of the input to output wires. The spin current was calculated by integration of the spin current density over the wire cross section.

As in the second example, when a spin drain attracts spin current, the spin relaxation becomes slower. As can be seen from Fig. 11, the spin relaxation in the input wire becomes slower in the case of a wider output wire (blue and magenta lines) and the spin relaxation becomes faster in the case of a narrower output wire (green and red lines). Therefore, the wire of wider width could be considered as an effective spin drain.

IX. CONCLUSION

The equations, which describe spin and charge transport in materials with spin-dependent conductivity, were derived from the spin and charge conservation laws. It was shown that the spin and charge transport is distinguishably different in the three types of materials: nonmagnetic metals, ferromagnetic metals, and semiconductors.

The conductivity of nonmagnetic metals is spin independent and there is no interaction between the spin diffusion current and the charge drift current in nonmagnetic metals.

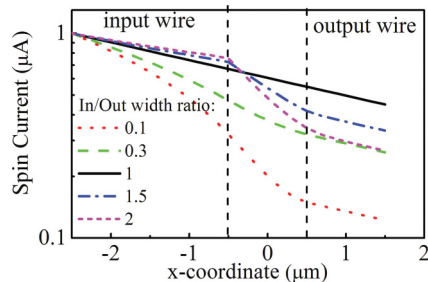


FIG. 11. (Color online) Magnitude of spin current along wire with variable width for different width ratios between input to output. The solid line represents the case of a straight wire.

In the case of nonmagnetic metals, the obtained spin/charge transport equations converge to the Valet-Fert spin diffusion equation.

The conductivity of ferromagnetic metals is spin dependent and the spin selectivity β is constant throughout the bulk of the metal. In a ferromagnetic metal the drift current has a spin-current component. In contrast to the diffusion spin current, the drift spin current does not decay along its flow direction.

In ferromagnetic metals there is a charge accumulation along the flow of the diffusion spin current. Because of the charge accumulation, the effective diffusion length in ferromagnetic metals becomes shorter. In materials in which the spin-selectivity β is close to 100%, the spin diffusion is blocked and the diffusion spin current cannot flow. In ferromagnetic metals there is no interaction between the dc diffusion and drift currents, but there is an interaction between the ac diffusion and drift currents.

The conductivity of semiconductors is spin dependent only in the presence of a spin accumulation. There is a substantial interaction between the diffusion and drift currents in semiconductors.

A unique feature of the spin transport in the semiconductors is the existence of the threshold spin current, above which the spins cannot diffuse. In the case when magnitude of the diffusion spin current is smaller, but near the magnitude of threshold spin current, a region of high spin and charge accumulation is formed.

In the semiconductors, the drift charge current modulates the effective spin diffusion length of the diffusion current. In the case of the same flow direction of diffusion and drift current, the effective spin diffusion length becomes longer, the spin relaxation becomes slower, and the spin diffusion current are gained from the drift current. In the case of the opposite flow directions, the effective spin diffusion length becomes shorter, the spin relaxation becomes faster, and the spin diffusion current are damped by the drift current.

A spin drain plays an important role in the spin transport in nonmagnetic metal, ferromagnetic metals, and semiconductors. The attraction of spin current by the spin drain and the influence of the spin drain on the spin diffusion length always should be considered for design optimization of spintronic devices.

APPENDIX

In the Appendix we prove the validity of Eq. (9), which states that the rate of spin relaxation is linearly proportional to the spin chemical potential μ_{spin} . Also, the features of spin transport in the case, when Eq. (9) is not valid, are discussed.

The following is the calculation of the spin relaxation for a material in which there is a charge spin accumulation. In the case when the energy is conserved during spin-flip scattering, the rate of spin relaxation is calculated using Fermi's golden rule as

$$\frac{\partial n_S}{\partial t} = \int P_{\uparrow} N_{\uparrow}(E) N_{\downarrow}(E) F\left(\frac{E - E_F - \Delta E_{\uparrow}}{kT}\right) \times \left[1 - F\left(E + \frac{E - E_F - \Delta E_{\uparrow}}{kT}\right)\right] dE$$

$$- \int P_{\downarrow} N_{\uparrow}(E) N_{\downarrow}(E) F \left(\frac{E - E_F + \Delta E_{\downarrow}}{kT} \right) \times \left[1 - F \left(\frac{E - E_F + \Delta E_{\downarrow}}{kT} \right) \right] dE, \quad (\text{A1})$$

where n_S is the number of accumulated spins, $P_{\uparrow}, P_{\downarrow}$ are the probabilities for the transition from the spin-up band to the spin-down band and transition from the spin-down band to the spin-up band, respectively. $N_{\uparrow}, N_{\downarrow}$ are the densities of states for spin-up to spin-down bands. $F(E)$ is the Fermi-Dirac distribution. E_F is the Fermi energy in case when there is no charge and spin accumulations. $\Delta E_{\uparrow}, \Delta E_{\downarrow}$ is the change of the Fermi energy due to a charge and/or spin accumulation.

In the case when there is no spin accumulation, $\Delta E_{\uparrow} = \Delta E_{\downarrow}$ and there is no spin relaxation $\frac{\partial n_S}{\partial t} = 0$. That leads to $P_{\uparrow} = P_{\downarrow} = P$.

In the case when the charge and spin accumulations are small

$$\frac{\Delta E_{\uparrow}}{kT} \ll 1, \quad \frac{\Delta E_{\downarrow}}{kT} \ll 1 \quad (\text{A2})$$

Equation (A1) is simplified to

$$\begin{aligned} \frac{\partial n_S}{\partial t} = & \int P N_{\uparrow}(E) N_{\downarrow}(E) \left(F_0 - F' \frac{\Delta E_{\uparrow}}{kT} \right) \\ & \times \left[1 - F_0 + F' \frac{\Delta E_{\uparrow}}{kT} \right] dE \\ & - \int P N_{\uparrow}(E) N_{\downarrow}(E) \left(F_0 + F' \frac{\Delta E_{\downarrow}}{kT} \right) \\ & \times \left[1 - F_0 - F' \frac{\Delta E_{\downarrow}}{kT} \right] dE. \end{aligned} \quad (\text{A3})$$

Simplifying Eq. (A3) we obtain

$$\begin{aligned} \frac{\partial n_S}{\partial t} = & \frac{\Delta E_{\uparrow} - \Delta E_{\downarrow}}{kT} \int P N_{\uparrow}(E) N_{\downarrow}(E) F'(2F_0 - 1) dE \\ = & A (\Delta E_{\uparrow} - \Delta E_{\downarrow}), \end{aligned} \quad (\text{A4})$$

where

$$\begin{aligned} F_0 = & F \left(\frac{E - E_F}{kT} \right) F' = \frac{\partial F \left(\frac{E - E_F}{kT} \right)}{\partial E} \\ A = & \frac{1}{kT} \int P N_{\uparrow}(E) N_{\downarrow}(E) F'(2F_0 - 1) dE \end{aligned}$$

Since

$$\Delta E_{\uparrow} - \Delta E_{\downarrow} = \mu_{\uparrow} - \mu_{\downarrow} = \mu_{\text{spin}}, \quad (\text{A5})$$

Eq. (A4) will be

$$\frac{\partial n_S}{\partial t} = A \mu_{\text{spin}}. \quad (\text{A6})$$

The expression (A6) states that if condition (A2) is satisfied, the spin relaxation is linearly proportional to μ_{spin} . Therefore, the spin diffusion length does not depend on spin or charge accumulation.

In the case when condition (A2) is not satisfied, the parameter A is a function of the charge accumulation ρ_{charge} and the spin accumulation ρ_{spin} :

$$\frac{\partial n_S}{\partial t} = A(\rho_{\text{charge}}, \rho_{\text{spin}}) \mu_{\text{spin}}. \quad (\text{A7})$$

The spin accumulation is proportional to the spin chemical potential and the charge accumulation is proportional to the second derivative of the charge chemical potential. Noticing that $\frac{\partial n_S}{\partial t}$ and μ_{spin} change their signs under the time reversal transformation, Eq. (A7) can be rewritten as

$$\frac{\partial n_S}{\partial t} = A(\mu_{\text{spin}}^2, \nabla^2 \mu_{\text{charge}}) \mu_{\text{spin}}. \quad (\text{A8})$$

Therefore, at sufficiently large spin or charge accumulation, the spin diffusion length may depend on the magnitude of the spin or charge accumulation. This dependence may significantly influence spin transport in the cases when the spin diffusion current in a semiconductor is close to the threshold spin current.

The Coulomb electron-electron interaction may be a primary reason for the nonlinear dependence (A8) of the spin relaxation on the spin and charge accumulations.²⁰

*v.zayets@aist.go.jp

¹Y. Ohno, D. K. Young, B. Beschoten, F. Matsukura, H. Ohno, and D. D. Awschalom, *Nature (London)* **402**, 790 (1999).

²R. Fiederling, M. Keim, G. Reuscher, W. Ossau, G. Schmidt, A. Waag, and L. W. Molenkamp, *Nature (London)* **402**, 787 (1999).

³V. F. Motsnyi, V. I. Safarov, J. De Boeck, J. Das, W. Van Roy, E. Goovaerts, and G. Borghs, *Appl. Phys. Lett.* **81**, 265 (2002).

⁴B. T. Jonker, G. Kioseoglou, A. T. Hanbicki, C. H. Li, and P. E. Thompson, *Nat. Phys.* **3**, 542 (2007).

⁵O. M. J. van't Erve, G. Kioseoglou, A. T. Hanbicki, C. H. Li, B. T. Jonker, R. Mallory, M. Yasar, and A. Petrou, *Appl. Phys. Lett.* **84**, 4334 (2004).

⁶S. P. Dash, S. Sharma, R. S. Patel, M. P. de Jong, and R. Jansen, *Nature (London)* **462**, 491 (2009).

⁷T. Suzuki, T. Sasaki, T. Oikawa, M. Shiraishi, Y. Suzuki, and K. Noguchi, *Appl. Phys. Express* **4**, 023003 (2011).

⁸F. J. Jedema, A. T. Filip, and B. J. van Wees, *Nature (London)* **410**, 345 (2001).

⁹Y. Kato, R. C. Myers, A. C. Gossard, and D. D. Awschalom, *Science* **306**, 1910 (2004).

¹⁰E. Saitoh, M. Ueda, H. Miyajima, and G. Tatara, *Appl. Phys. Lett.* **88**, 182509 (2006).

¹¹H. C. Koo, J. H. Kwon, J. Eom, J. Chang, S. H. Han, and M. Johnson, *Science* **325**, 1515 (2009).

¹²D. J. Monsma, J. C. Lodder, T. J. A. Popma, and B. Dieny, *Phys. Rev. Lett.* **74**, 5260 (1995).

¹³S. van Dijken, X. Jiang, and S. S. P. Parkin, *Phys. Rev. B* **66**, 094417 (2002).

¹⁴R. Jansen, *J. Phys. D* **36**, R289 (2003).

- ¹⁵S. Yuasa, T. Nagahama, A. Fukushima, Y. Suzuki, and K. Ando, *Nat. Mater.* **3**, 868 (2004).
- ¹⁶S. S. P. Parkin, C. Kaiser, A. Panchula, P. M. Rice, B. Hughes, M. Samant, and S.-H. Yang, *Nat. Mater.* **3**, 862 (2004).
- ¹⁷T. Valet and A. Fert, *Phys. Rev.B.* **48**, 7099 (1993).
- ¹⁸M. R. Sears and W. M. Saslow, *Phys. Rev.B.* **85**, 014404 (2012).
- ¹⁹S. Iba, H. Saito, A. Spiesser, S. Watanabe, R. Jansen, S. Yuasa, and K. Ando, *Appl. Phys. Express* **5**, 023003 (2012).
- ²⁰I. D'Amico and G. Vignale, *Phys. Rev. B* **65**, 085109 (2002).